

IPD30N08S2L-21-VB Datasheet

N-Channel 100-V (D-S) MOSFET

PRODUCT SUMMARY			
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A) ^a	Q_g (Typ.)
100	0.0185 at $V_{GS} = 10$ V	45	38 nC

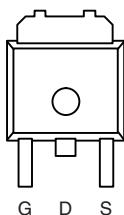
FEATURES

- Trench Power MOSFET
- 100 % R_g and UIS Tested

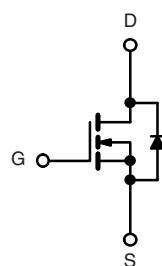


RoHS
COMPLIANT

TO-252



Top View



N-Channel MOSFET

APPLICATIONS

- Primary Side Switch
- Isolated DC/DC Converter

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C, unless otherwise noted)			
Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ($T_J = 150$ °C)	I_D	45 ^a	
		30	
		9.2 ^b	
		6.8 ^b	
Pulsed Drain Current	I_{DM}	140	A
Continuous Source-Drain Diode Current	I_S	45 ^a	
		2 ^b	
Single Pulse Avalanche Current	I_{AS}	35	
Avalanche Energy	E_{AS}	101	mJ
Maximum Power Dissipation	P_D	136.4	W
		68.2	
		3 ^b	
		1.5 ^b	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^b	R_{thJA}	40	50	°C/W
Maximum Junction-to-Case		0.85	1.1	

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

SPECIFICATIONS ($T_J = 25^\circ\text{C}$, unless otherwise noted)

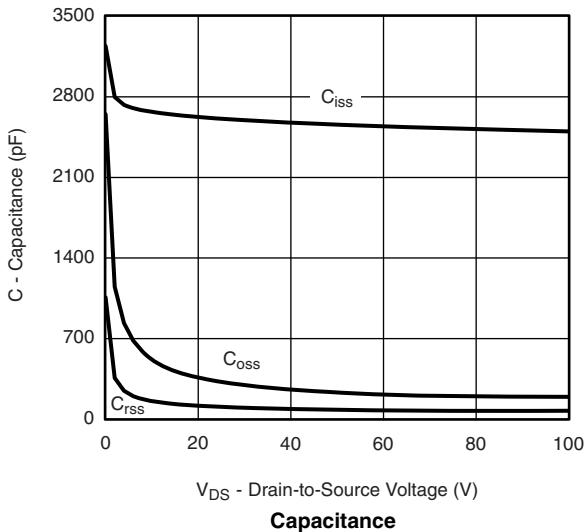
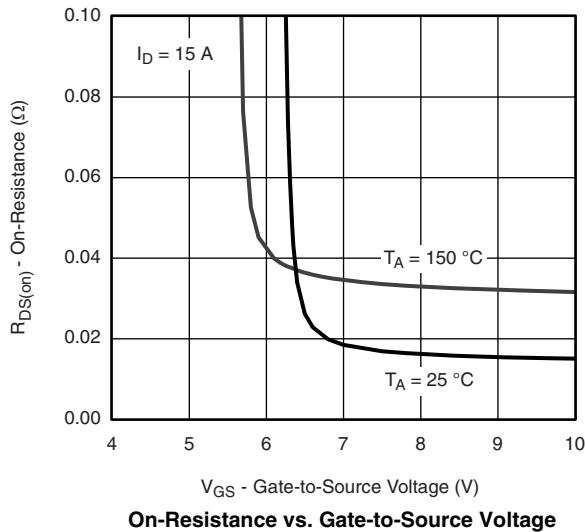
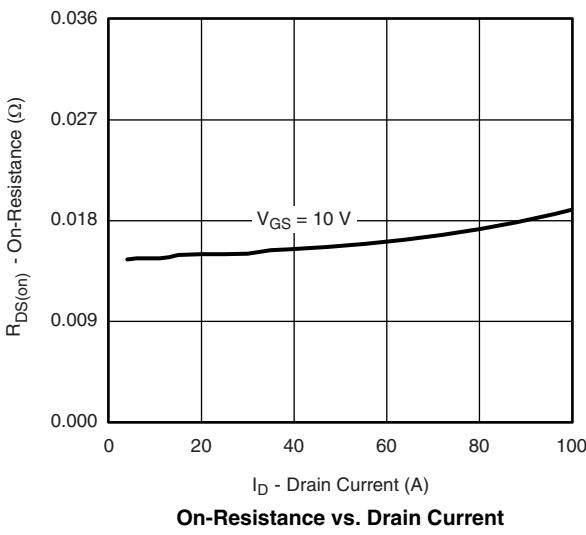
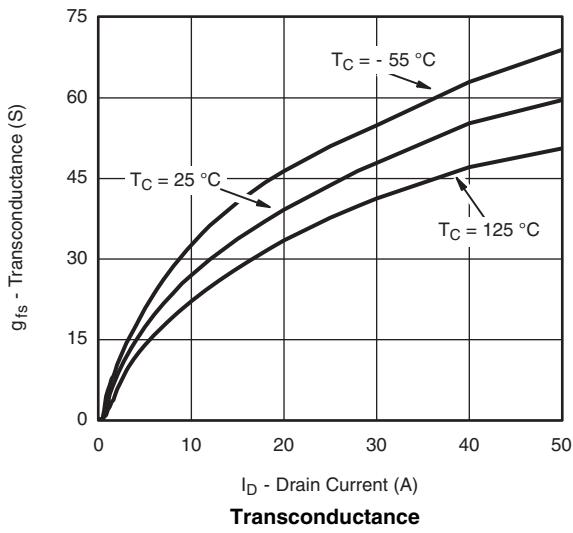
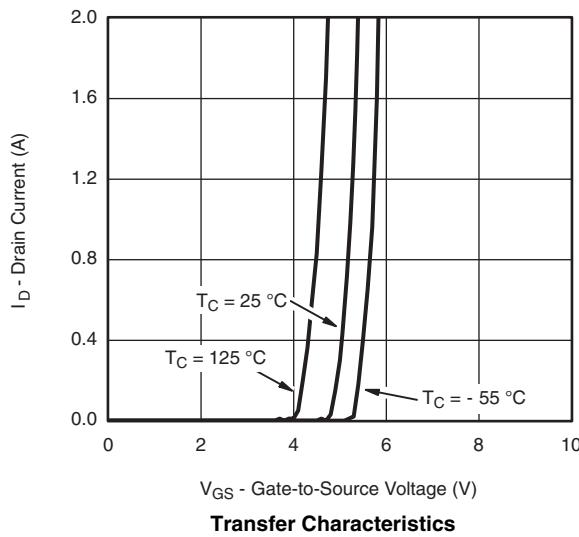
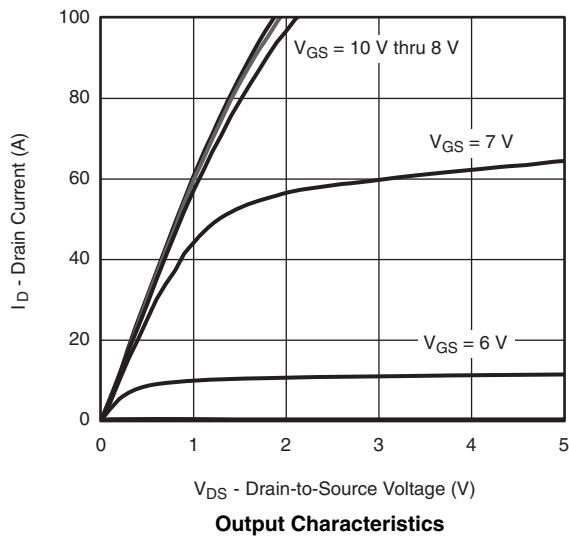
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$	100			V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250 \mu\text{A}$		110		mV/°C
$V_{GS(\text{th})}$ Temperature Coefficient	$\Delta V_{GS(\text{th})}/T_J$			- 12.5		
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	2.5		5	V
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}$, $V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 100 \text{ V}$, $V_{GS} = 0 \text{ V}$			1	μA
		$V_{DS} = 100 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_J = 125^\circ\text{C}$			50	
On-State Drain Current ^a	$I_{D(\text{on})}$	$V_{DS} \geq 5 \text{ V}$, $V_{GS} = 10 \text{ V}$	30			A
Drain-Source On-State Resistance ^a	$R_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}$, $I_D = 15 \text{ A}$		0.0185		Ω
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15 \text{ V}$, $I_D = 15 \text{ A}$		33		S
Dynamic^b						
Input Capacitance	C_{iss}	$V_{DS} = 50 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$		2400		pF
Output Capacitance	C_{oss}			230		
Reverse Transfer Capacitance	C_{rss}			80		
Total Gate Charge	Q_g	$V_{DS} = 50 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 50 \text{ A}$		38	70	nC
Gate-Source Charge	Q_{gs}			14		
Gate-Drain Charge	Q_{gd}			12		
Gate Resistance	R_g	$f = 1 \text{ MHz}$		1.6	2.5	Ω
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{DD} = 50 \text{ V}$, $R_L = 1 \Omega$ $I_D \geq 50 \text{ A}$, $V_{GEN} = 10 \text{ V}$, $R_g = 1 \Omega$		12	20	ns
Rise Time	t_r			10	20	
Turn-Off Delay Time	$t_{d(\text{off})}$			18	35	
Fall Time	t_f			8	15	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode	I_S	$T_C = 25^\circ\text{C}$			35	A
Pulse Diode Forward Current ^a	I_{SM}				100	
Body Diode Voltage	V_{SD}	$I_S = 15 \text{ A}$		0.85	1.5	V
Body Diode Reverse Recovery Time	t_{rr}	$I_F = 50 \text{ A}$, $di/dt = 100 \text{ A}/\mu\text{s}$, $T_J = 25^\circ\text{C}$		80	120	ns
Body Diode Reverse Recovery Charge	Q_{rr}			160	240	nC
Reverse Recovery Fall Time	t_a			57		ns
Reverse Recovery Rise Time	t_b			23		

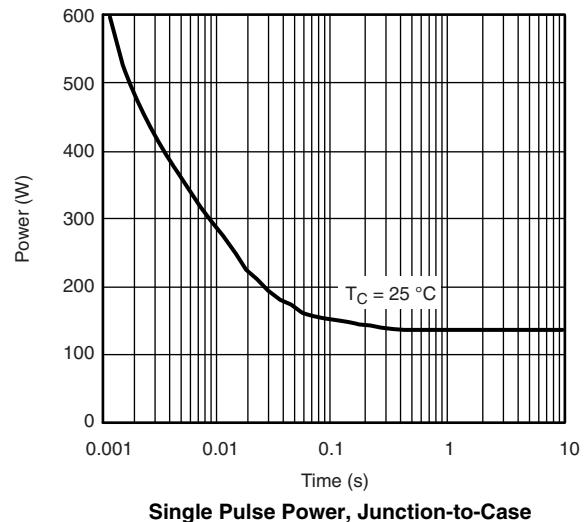
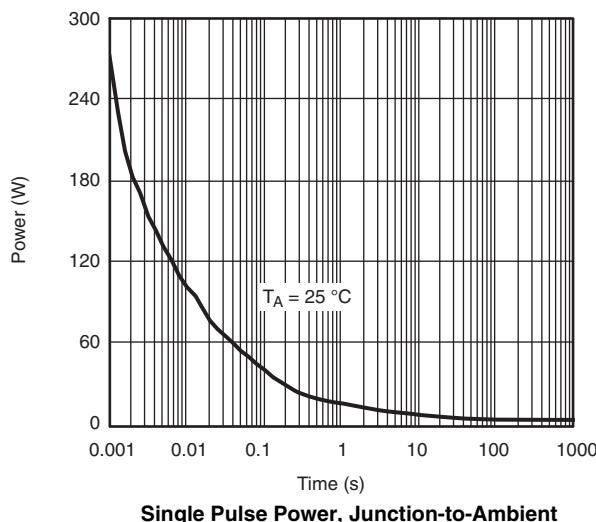
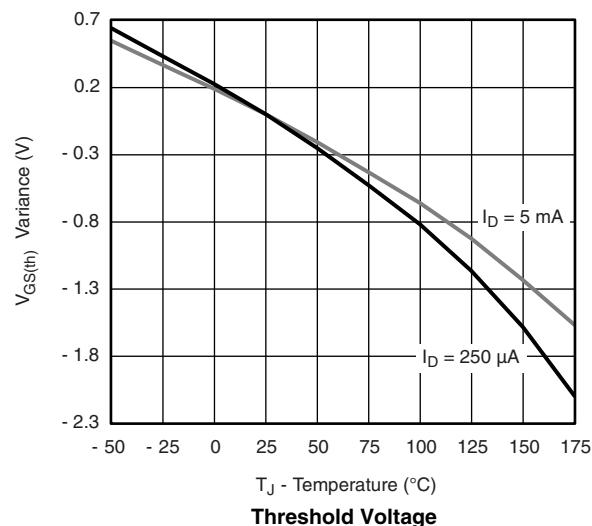
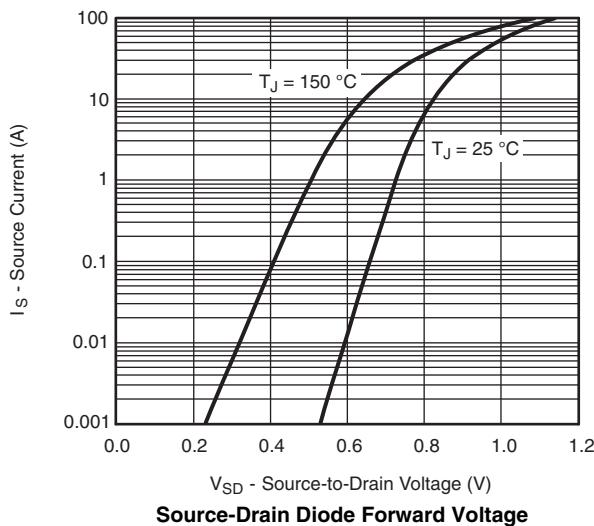
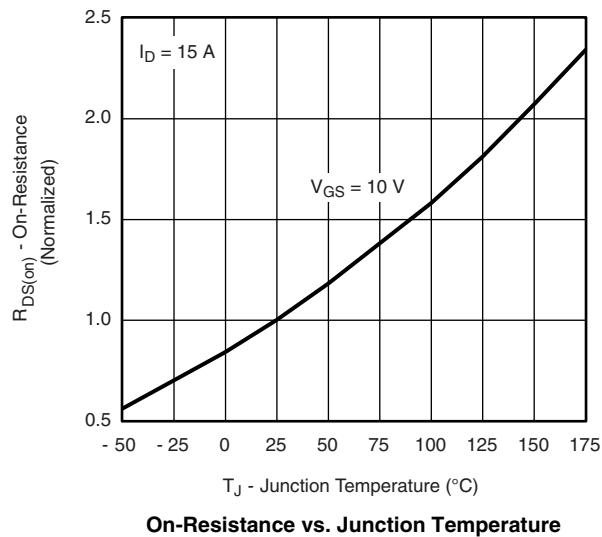
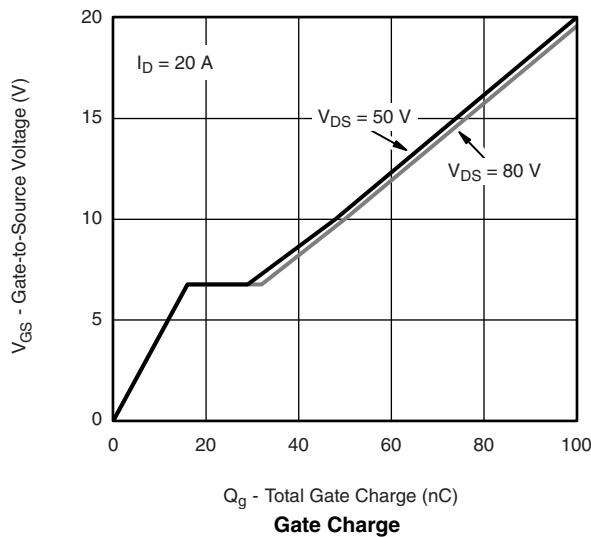
Notes:

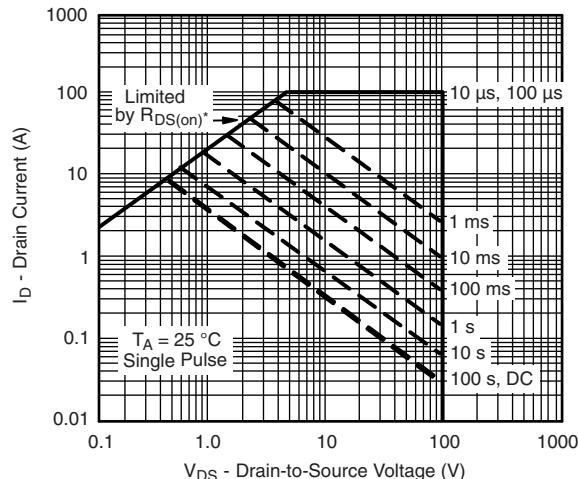
a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.

b. Guaranteed by design, not subject to production testing.

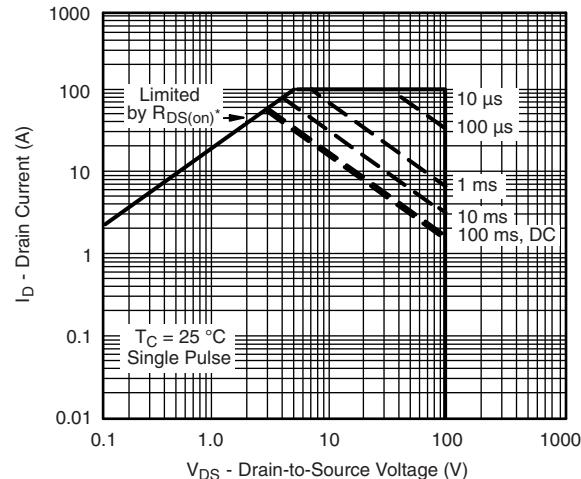
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise note)


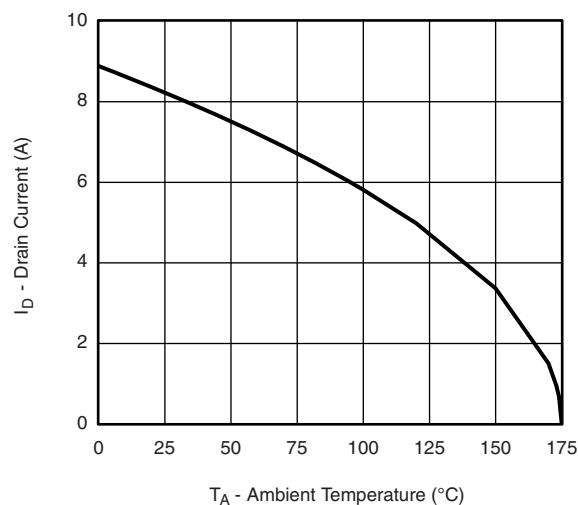
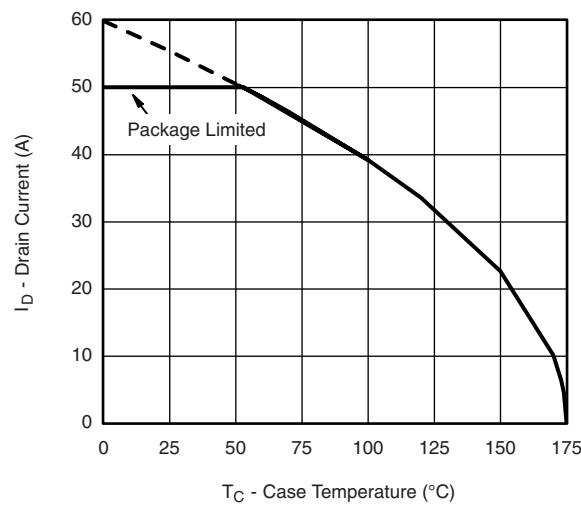
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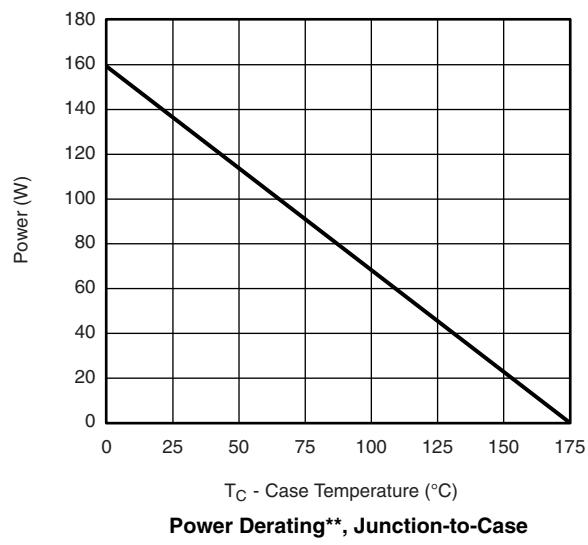
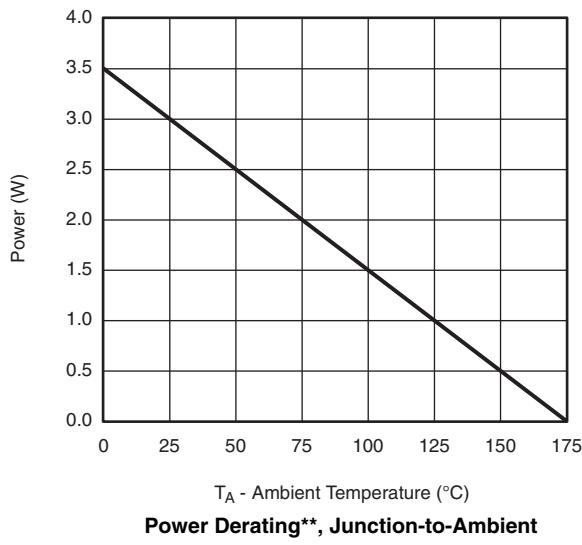
* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient


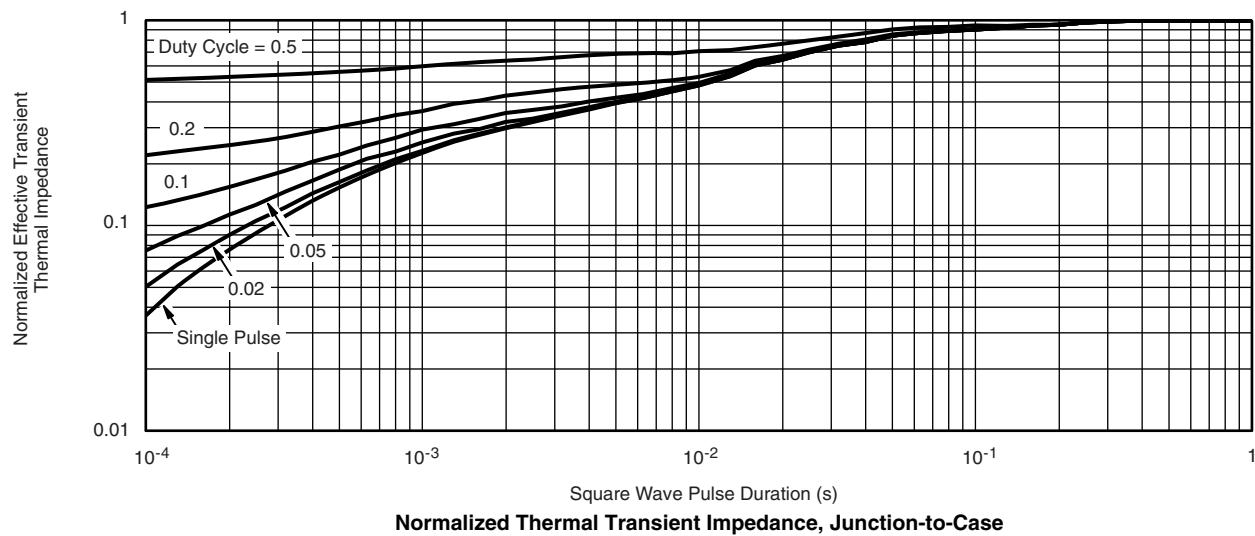
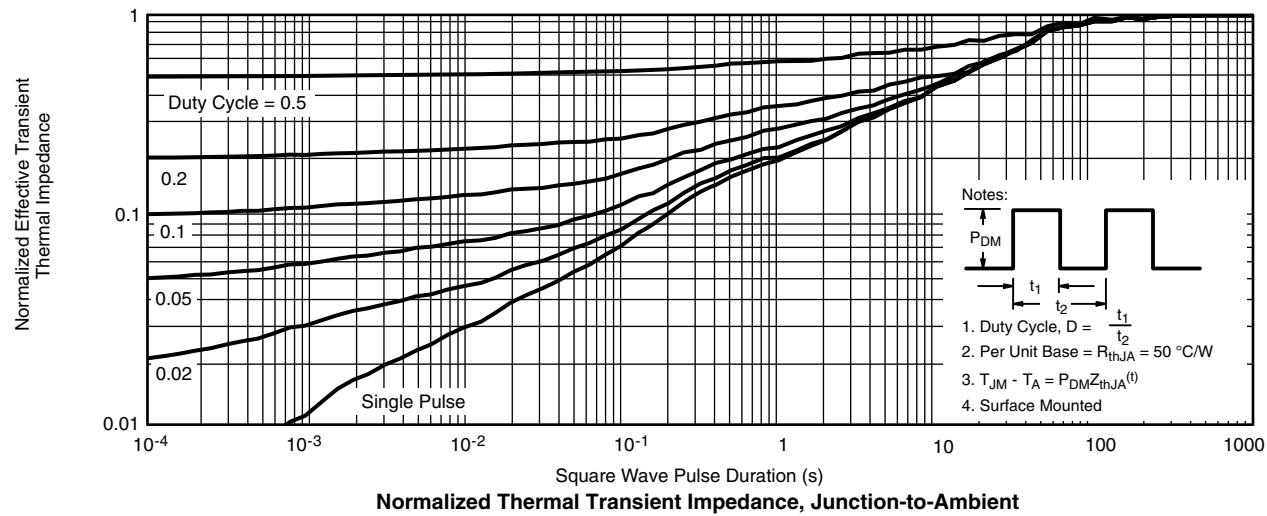
* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Case

Current Derating, Junction-to-Ambient**

Current Derating, Junction-to-Case**

** The power dissipation P_D is based on $T_{J(max.)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)


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